

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	226	((hydrogen adj bond\$4) near4 resin) and (layered or clay or mica)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/30 15:06
L2	179	1 and (perme\$8 or impermeab\$6 or air or gas)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/30 15:07
L3	72	2 and (pva or (polyvinyl adj alcohol))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/30 15:21
L4	11	2 and tire	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/30 16:02
L42	938	b60c005/14.ipc.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/30 20:15
L43	130	42 and thermoplastic	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/30 20:55
S64	259	152/510.ccls. or 152/dig16.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/28 19:35
S65	31	S64 and (layered or clay or platy or mica)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/28 19:35
S67	74	b60c005/14.ipc.	US-PGPUB; USPAT; USOCR	OR	ON	2005/09/28 19:46
S68	937	b60c005/14.ipc.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/28 19:46

S70	72	S68 and (mica or clay or platy or layered or nanocomposite)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/28 20:00
S79	158058	(platy or clay or nanocomposite or layered or mica or lamell\$5).ab.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/28 20:31
S80	1603	S79 and tire	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/28 20:31
S81	307	S80 and (liner or innerliner or impermea\$6 or permea\$9)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/28 20:32
S86	6169	((polyvinyl adj alcohol) or pva) same (clay or nanocomposite or lamell\$4 or platy or layered or mica)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/28 21:57
S87	6234	((polyvinyl adj alcohol) or pva) same (clay or nanocomposite or lamell\$4 or platy or layered or mica or interca\$8)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/28 21:57
S88	105	S87 and tire	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/28 22:07
S91	28	152/510.ccls. and resin.ab.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/28 22:19